

Features

- High Power Rating
- Low Capacitance
- Low Leakage Current
- Low Clamping Voltage
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

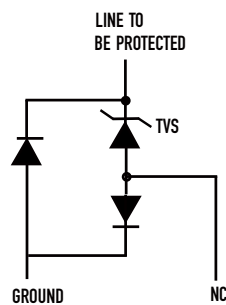
- Operating Junction Temperature Range: 55°C to +150°C
- Storage Temperature Range: -55°C to +150°C

MCC Part Number	Device Marking
ESDLC5V0C2	V5C1

IEC61000-4-2(ESD)	Air Contact	±25KV ±25KV
Peak Pulse Power (8/20us)	P _{PK}	650W

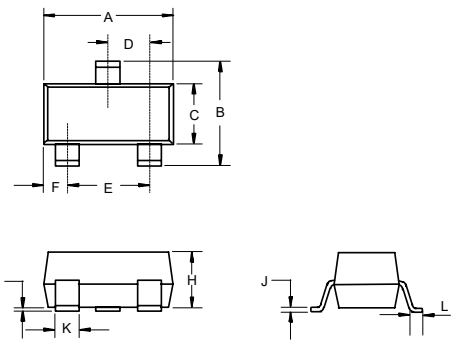
Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Internal Structure



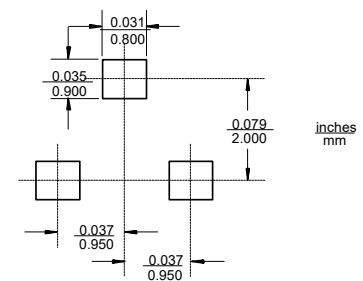
ESD Protection Device

SOT-23



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.083	0.104	2.10	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
H	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout



Electrical Characteristics (Between I/O to GND) @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Working Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	6		8	V
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$			1	μA
Forward Voltage	V_F	$I_F = 10\text{mA}$			0.9	V
Clamping Voltage	V_C	$I_{PP} = 25\text{A}$, $t_p = 8/20\mu\text{s}$			26	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1.3	2	pF

Curve Characteristics

Fig. 1 - 8 X 20µs Pulse Waveform

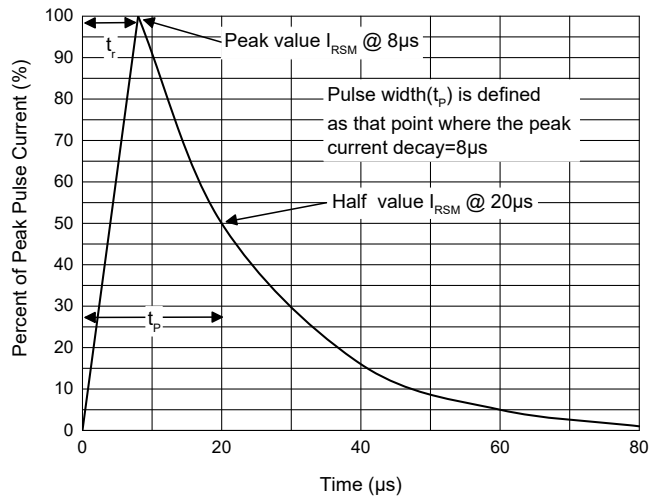


Fig. 2 - Pulse Derating Curve

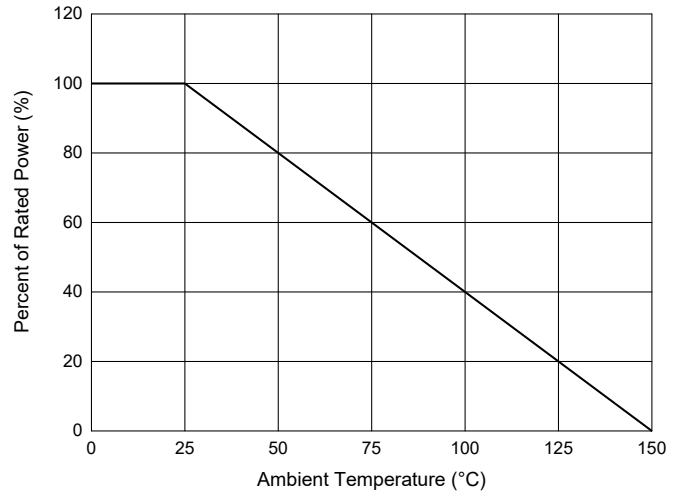


Fig. 3 - Capacitance Characteristics

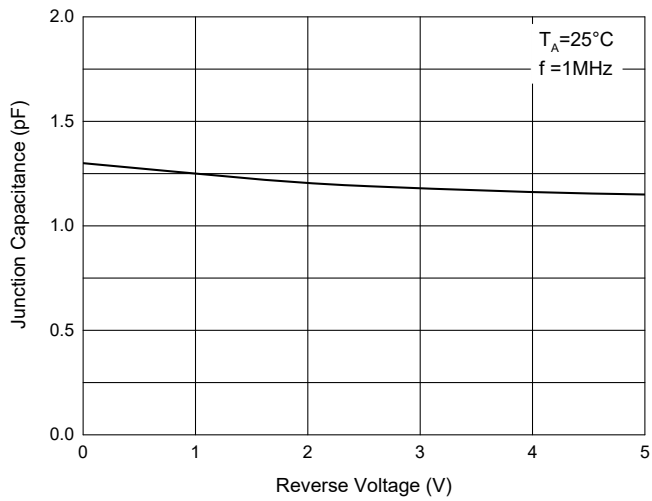


Fig. 4 - Clamping Voltage Characteristics

